

**TABLE 6.** Japan's HDI microvia board production in 2003

LAYER COUNT	100 MILLION Y	\$ MILLION	meters <sup>2</sup> in 1000s	\$/meters <sup>2</sup>	\$/sq. in
4	42.4	40.4	112.3	360	0.233
6	425.7	405.4	740.9	547	0.355
8	527.4	502.6	747.1	673	0.437
10+	64.6	61.5	47.8	1,287	0.835
Subtotal	1060.1	1009.9	1648.1	613	0.398
Flex microvia	0.2	0.2	0.2	1,000	0.992
IC Substrate	1057.9	1007.0	582.4	1,652	1.072
<b>TOTAL</b>	<b>2118.2</b>	<b>2017.1</b>	<b>2230.7</b>	<b>904</b>	<b>0.587</b>

Source: JPCA & N.T. Information Ltd. Note: In 2004 exchange rate.